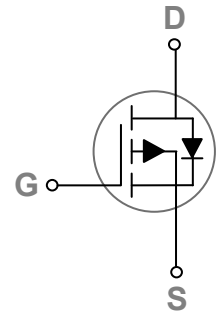


### Main Product Characteristics

$V_{(BR)DSS}$	-60V
$R_{DS(on)}$	190m $\Omega$
$I_D$	-2A



SOT-23



Schematic Diagram

### Features and Benefits

- Advanced MOSFET process technology
- Ideal for motor drive, power tools and LED lighting
- Low on-resistance with low gate charge
- Fast switching and reverse body recovery



### Description

The SSF6911S utilizes the latest techniques to achieve high cell density, low on-resistance and high repetitive avalanche rating. These features make this device extremely efficient and reliable for use in high efficiency switch mode power supply and a wide variety of other applications.

### Absolute Maximum Ratings ( $T_C=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	-60	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Drain Current – Continuous ( $T_C=25^\circ\text{C}$ )	$I_D$	-2	A
Drain Current – Continuous ( $T_C=100^\circ\text{C}$ )		-1.25	A
Drain Current – Pulsed <sup>1</sup>	$I_{DM}$	-8	A
Power Dissipation ( $T_C=25^\circ\text{C}$ )	$P_D$	1.56	W
Power Dissipation – Derate above $25^\circ\text{C}$	$P_D$	0.012	W/ $^\circ\text{C}$
Storage Temperature Range	$T_{STG}$	-50 to +150	$^\circ\text{C}$
Operating Junction Temperature Range	$T_J$	-50 to +150	$^\circ\text{C}$

### Thermal Characteristics

Parameter	Symbol	Typ	Max	Unit
Thermal Resistance Junction to Ambient	$R_{\theta JA}$	---	80	$^\circ\text{C}/\text{W}$

**Electrical Characteristics** ( $T_J=25^\circ\text{C}$  unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=-250\mu A$	-60	---	---	V
$BV_{DSS}$ Temperature Coefficient	$\Delta BV_{DSS}/\Delta T_J$	Reference to $25^\circ\text{C}$ , $I_D=-1mA$	---	-0.05	---	$V/^\circ\text{C}$
Drain-Source Leakage Current	$I_{DSS}$	$V_{DS}=-60V, V_{GS}=0V, T_J=25^\circ\text{C}$	---	---	-1	$\mu A$
		$V_{DS}=-48V, V_{GS}=0V, T_J=125^\circ\text{C}$	---	---	-10	$\mu A$
Gate-Source Leakage Current	$I_{GSS}$	$V_{GS}=\pm 20V, V_{DS}=0V$	---	---	$\pm 100$	$\mu A$
<b>On Characteristics</b>						
Static Drain-Source On-Resistance	$R_{DS(ON)}$	$V_{GS}=-10V, I_D=-2A$	---	160	190	$m\Omega$
		$V_{GS}=-4.5V, I_D=-1.5A$	---	200	240	
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS}=V_{DS}, I_D=-250\mu A$	-1.2	-1.9	-2.5	V
$V_{GS(th)}$ Temperature Coefficient	$\Delta V_{GS(th)}$		---	5	---	$mV/^\circ\text{C}$
Forward Transconductance	$g_{fs}$	$V_{DS}=-10V, I_S=-2A$	---	3.5	---	S
<b>Dynamic and Switching Characteristics</b>						
Total Gate Charge <sup>2, 3</sup>	$Q_g$	$V_{DS}=-30V, V_{GS}=-10V, I_D=-2A$	---	8.2	12	$nC$
Gate-Source Charge <sup>2, 3</sup>	$Q_{gs}$		---	1.8	3.6	
Gate-Drain Charge <sup>2, 3</sup>	$Q_{gd}$		---	1.5	3	
Turn-On Delay Time <sup>2, 3</sup>	$T_{d(on)}$	$V_{DD}=-30V, V_{GS}=-10V, R_G=6\Omega, I_D=-1A$	---	5.2	10	$nS$
Rise Time <sup>2, 3</sup>	$T_r$		---	19	36	
Turn-Off Delay Time <sup>2, 3</sup>	$T_{d(off)}$		---	35	67	
Fall Time <sup>2, 3</sup>	$T_f$		---	10.6	20	
Input Capacitance	$C_{iss}$	$V_{DS}=-30V, V_{GS}=0V, F=1MHz$	---	425	615	$pF$
Output Capacitance	$C_{oss}$		---	35	50	
Reverse Transfer Capacitance	$C_{rss}$		---	20	30	
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
Continuous Source Current	$I_S$	$V_G=V_D=0V$ , Force Current	---	---	-2	A
Pulsed Source Current	$I_{SM}$		---	---	-4	A
Diode Forward Voltage	$V_{SD}$	$V_{GS}=0V, I_S=-1A, T_J=25^\circ\text{C}$	---	---	-1	V

**Notes :**

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. The data tested by pulsed , pulse width  $\leq 300\mu s$  , duty cycle  $\leq 2\%$ .
3. Essentially independent of operating temperature.

### Typical Electrical and Thermal Characteristic Curves

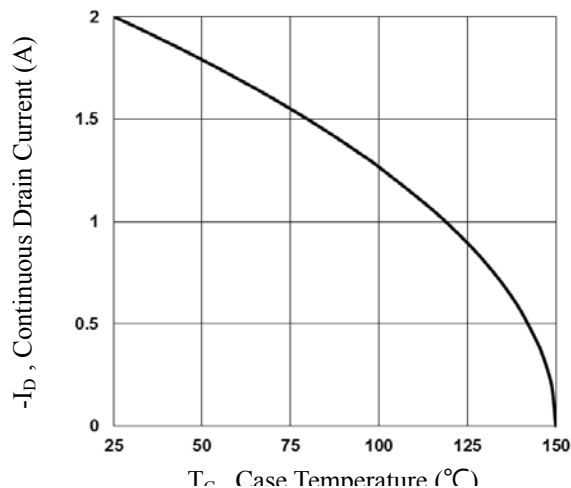


Fig.1 Continuous Drain Current vs.  $T_c$

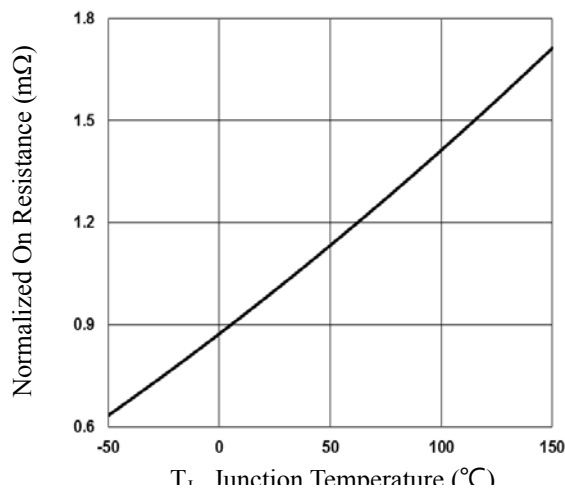


Fig.2 Normalized  $R_{DS(on)}$  vs.  $T_j$

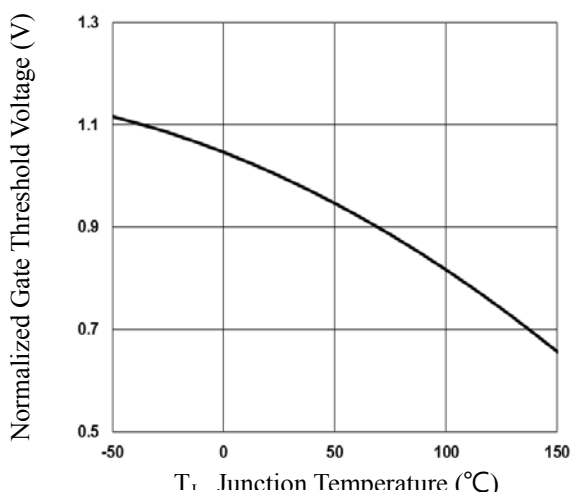


Fig.3 Normalized  $V_{th}$  vs.  $T_j$

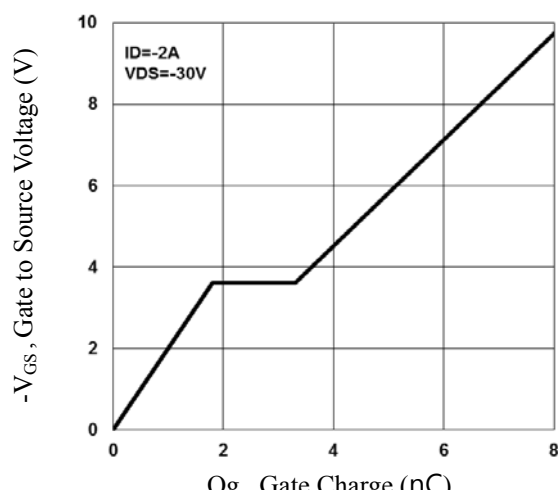


Fig.4 Gate Charge Waveform

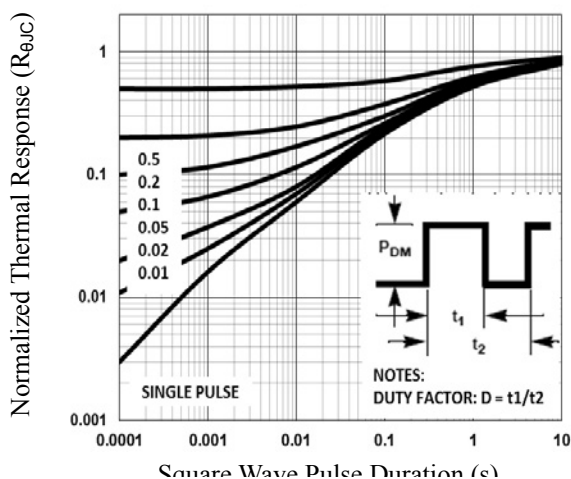


Fig.5 Normalized Transient Impedance

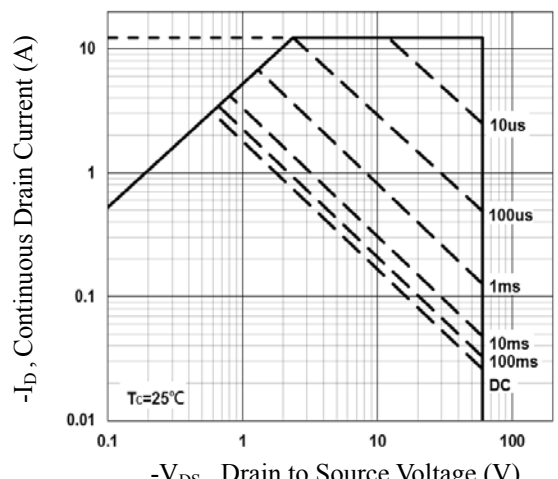


Fig.6 Maximum Safe Operation Area

**Typical Electrical and Thermal Characteristic Curves**

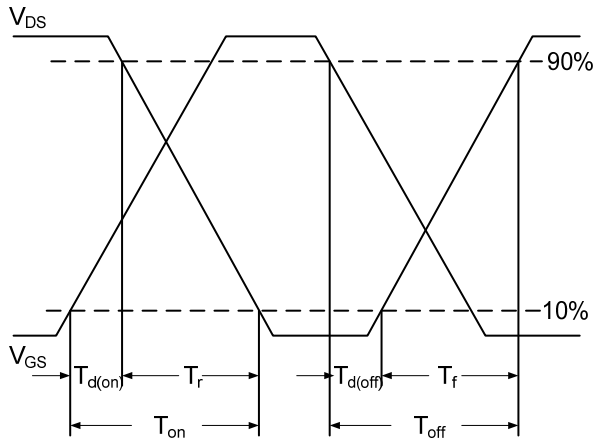


Fig.7 Switching Time Waveform

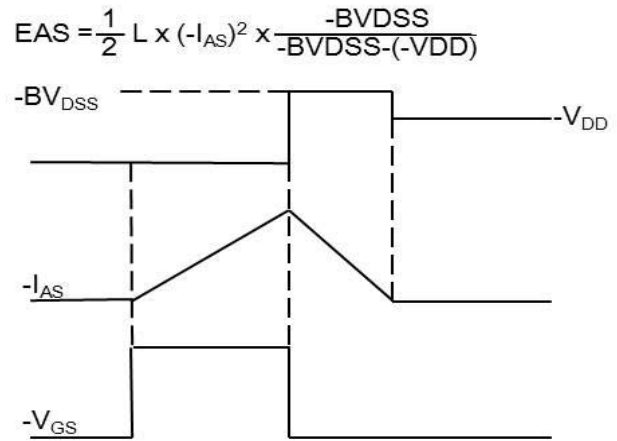
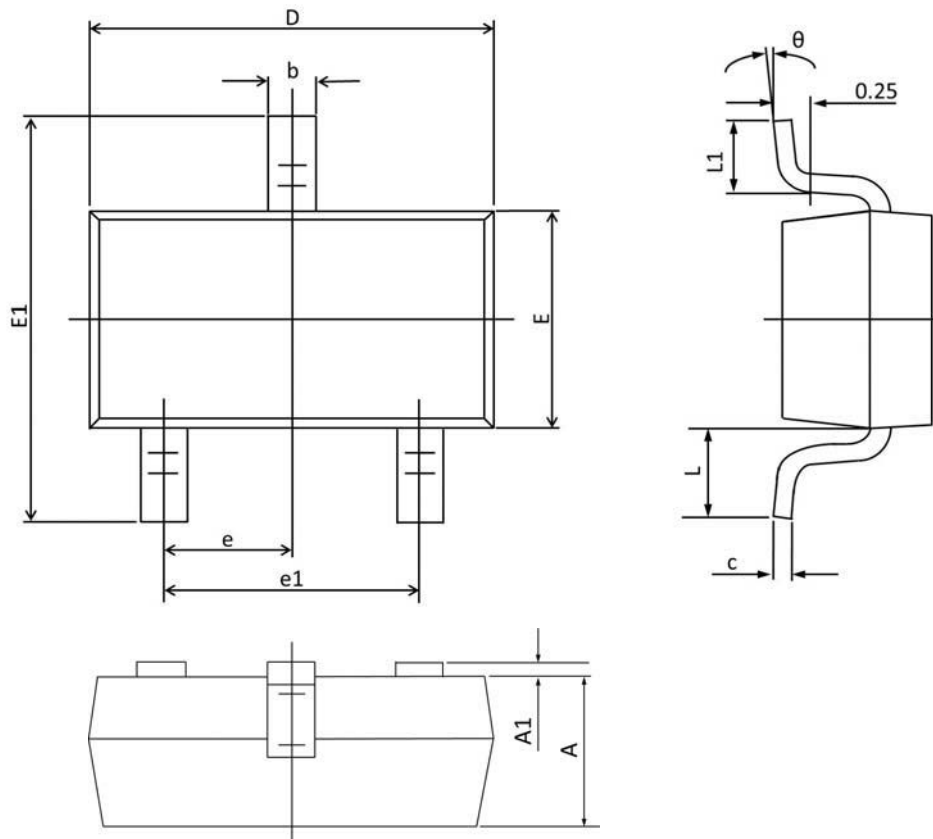


Fig.8 EAS Waveform

## Package Outline Dimensions

## SOT-23



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.000	0.035	0.039
A1	0.000	0.100	0.000	0.004
b	0.300	0.500	0.012	0.020
c	0.090	0.110	0.003	0.004
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP.		0.037 TYP.	
e1	1.800	2.000	0.071	0.079
L	0.550 REF.		0.022 REF.	
L1	0.300	0.500	0.012	0.020
θ	1°	7°	1°	7°